

General Description

The WSP4982 is the highest performance trench N-ch MOSFET with extreme high cell density, which provide excellent RDSON and gate chargens for most of the synchronous buck converter applications .

The WSP4982 meet the RoHS and Green Product requirement,100% EAS guaranteed with full function reliability approved.

Features

- Advanced high cell density Trench technology
- Super Low Gate Charge
- Excellent CdV/dt effect decline
- 100% EAS Guaranteed
- Green Device Available

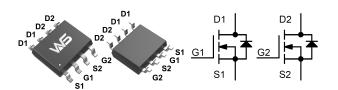
Product Summery

| BVDSS | RDSON | ID |
|-------|--------------|------|
| 40V | 24m Ω | 7.0A |

Applicatio

- Power Management in Note book.
- Battery Powered System.
- Industrial DC/DC Conversion Circuits

SOP-8 Pin Configuration



Absolute Maximum Ratings

| Symbol | Parameter | Rating | Units |
|--------------------------------------|---|------------|------------|
| V_{DS} | Drain-Source Voltage | 40 | V |
| V_{GS} | Gate-Source Voltage | ±20 | V |
| I _D @T _C =25℃ | Continuous Drain Current, V _{GS} @ 10V | 7.0 | Α |
| I _D @T _C =70℃ | Continuous Drain Current, V _{GS} @ 10V | 5.8 | Α |
| I _{DM} | Pulsed Drain Current ^a | 28 | Α |
| P _D @T _A =25℃ | Total Power Dissipation T _A =25°C | 1.5 | Α |
| P _D @T _A =70°C | Total Power Dissipation T _A =70°C | 1.28 | W |
| T _{STG} | Storage Temperature Range | -55 to 150 | °C |
| TJ | Operating Junction Temperature Range | -55 to 150 | $^{\circ}$ |

Thermal Data

| Symbol | Parameter | Typ. Max. | | Unit | |
|----------------|--------------------------------------|-----------|------|------|--|
| $R_{	heta JA}$ | Thermal Resistance Junction-ambient⁵ | | 110 | °C/W | |
| $R_{	heta JC}$ | Thermal Resistance Junction-Case | | 62.5 | °C/W | |

Note a : Pulse width limited by max. junction temperature. Note b : Surface Mounted on $1in^2$ pad area, t =999sec.

Note c: UIS tested and pulse width limited by maximum junction temperature 150° C (initial temperature $T_i=25^{\circ}$ C).





Electrical Characteristics (T_J=25 °C, unless otherwise noted)

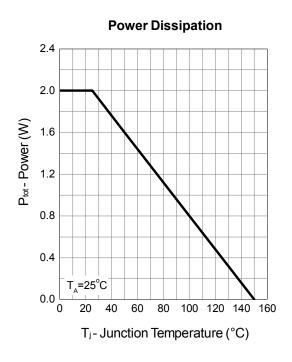
| Symbol | Parameter | Conditions | Min. | Тур. | Max. | Unit |
|-----------------------|--|---|------|------|------|------|
| BV _{DSS} | Drain-Source Breakdown Voltage | V_{GS} =0 V , I_D =250 u A | 40 | | | V |
| R _{DS(ON)} c | Static Drain-Source On-Resistance ² | V_{GS} =10V , I_D =6.0A | | 24 | 28 | mΩ |
| | | V_{GS} =4.5 V , I_D =5.0 A | | 28 | 33 | |
| V _{GS(th)} | Gate Threshold Voltage | $V_{GS}=V_{DS}$, $I_D=250uA$ | 1.0 | 1.6 | 2.5 | ٧ |
| I _{DSS} | Drain-Source Leakage Current | V_{DS} =24V , V_{GS} =0V , T_J =25 $^{\circ}$ C | | | 1 | - uA |
| | | V_{DS} =24V , V_{GS} =0V , T_J =55 $^{\circ}$ C | | | 30 | |
| I _{GSS} | Gate-Source Leakage Current | V_{GS} = $\pm 20 V$, V_{DS} = $0 V$ | | | ±100 | nA |
| Q_g^d | Total Gate Charge (4.5V) | | | 7.5 | | |
| Q _{gs} | Gate-Source Charge | V_{DS} =20V , V_{GS} =4.5V , I_{D} =6A | | 3.24 | | nC |
| Q_gd | Gate-Drain Charge | | | 2.75 | | |
| $T_{d(on)}$ | Turn-On Delay Time | | | 7.8 | | |
| Tr | Rise Time | V_{DD} =20V, V_{GEN} =10V, R_{G} =6 Ω | | 6.9 | | 20 |
| $T_{d(off)}$ | Turn-Off Delay Time | , I _D =1A,RL=20Ω. | | 22.4 | | ns |
| T _f | Fall Time | | | 4.8 | | |
| C _{iss} | Input Capacitance | | | 815 | | |
| C _{oss} | Output Capacitance | V_{DS} =20V , V_{GS} =0V , f=1MHz | | 95 | | pF |
| C _{rss} | Reverse Transfer Capacitance | | | 60 | | |

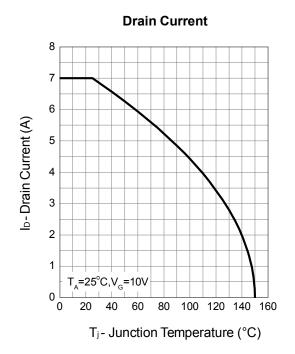
Note c : Pulse test ; pulse width \leq 300 μ s, duty cycle \leq 2%.

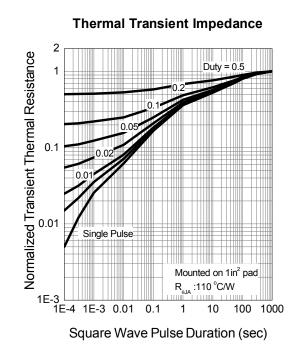
Note d: Guaranteed by design, not subject to production testing.



Typical Characteristics

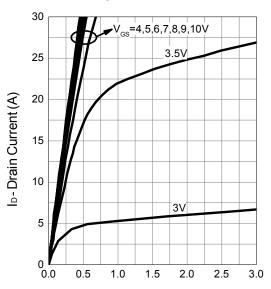






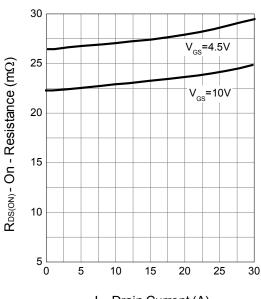


Output Characteristics



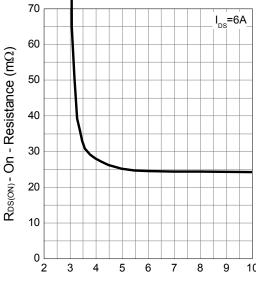
V_{DS}-Drain - Source Voltage (V)

Drain-Source On Resistance



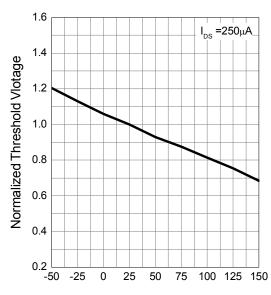
ID-Drain Current (A)

Gate-Source On Resistance



V_{GS} - Gate - Source Voltage (V)

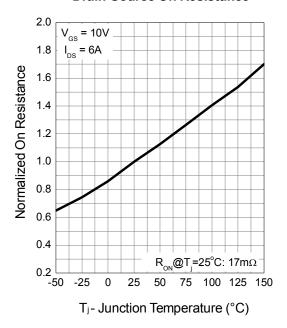
Gate Threshold Voltage



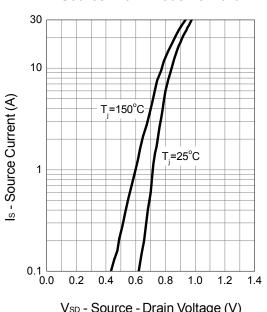
T_j - Junction Temperature (°C)



Drain-Source On Resistance

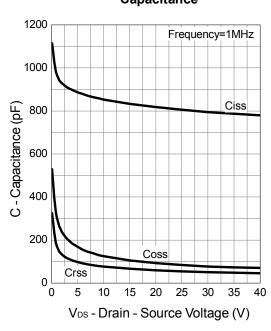


Source-Drain Diode Forward

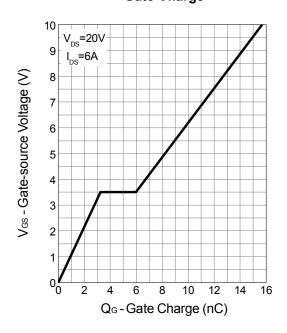


V_{SD} - Source - Drain Voltage (V)

Capacitance



Gate Charge





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